# GaAs INTEGRATED CIRCUIT <br> $\mu$ PG132G 

## L-BAND SPDT SWITCH

## DESCRIPTION

$\mu$ PG132G is an L-Band SPDT (Single Pole Double Throw) GaAs FET switch which was developed for digital cellular or cordless telephone application.

The device can operate from 100 MHz to 2.5 GHz , having the low insertion loss.
It housed in an original 8 pin SSOP that is smaller than usual 8 pin SOP and easy to install and contributes to miniaturizing the system.

It can be used in wide-band switching applications.

## FEATURES

- Maximum transmission power : 0.6 W (typ.)
- Low insertion loss : 0.6 dB (typ.) at $\mathrm{f}=2 \mathrm{GHz}$
- High switching speed : 30 ns
- +3 V/0 V control voltage
- Small package : 8 pins SSOP


## APPLICATION

- Digital cordless telephone : PHS, PCS, DECT etc.
- Digital hand-held cellular phone, WLAN


## ORDERING INFORMATION

| PART NUMBER | PACKAGE | PACKING FORM |
| :---: | :---: | :--- |
| $\mu$ PG132G-E1 | 8 pin plastic SSOP | Carrier tape width 12 mm. <br> QTY 2kp/Reel. |

For evaluation sample order, please contact your local NEC sales office.
ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Control Voltage | Vcont | -0.6 to +6 | V |
| :--- | :--- | :---: | :---: |
| Input Power | Pin | 31 | dBm |
| Total Power Dissipation | $\mathrm{P}_{\text {tot }}$ | 0.4 | W |
| Operating Case Temperature | $\mathrm{T}_{\text {opt }}$ | -65 to +90 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

## CAUTION: The IC must be handled with care to prevent static discharge because its circuit is composed of GaAs MES FET.

PIN CONNECTION DIAGRAM (Top View)


1. Vcont2
2. OUT2
3. GND
4. GND
5. IN
6. GND
7. OUT1
8. Vcont1

## SPDT SWITCH IC SERIES PRODUCTS

| PART NUMBER | $\begin{gathered} \text { Pin (1dB) } \\ (\mathrm{dBm}) \end{gathered}$ | Lins <br> (dB) | $\begin{aligned} & \text { ISL } \\ & \text { (dB) } \end{aligned}$ | VCont <br> (V) | PACKAGE | APPLICATIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mu$ PG130GR | +34 | 0.5 @1G | 32 @1G | -5/0 | $\begin{gathered} 8 \text { pin SOP } \\ (225 \mathrm{mil}) \end{gathered}$ | PDC, IS-136, PHS |
| $\mu \mathrm{PG131GR}$ | +30 | 0.6 @2G | 23 @2G | -4/0 |  | PHS, PCS, WLAN |
| $\mu$ PG130G | +34 | 0.5 @1G | 32 @1G | -5/0 | $\begin{gathered} 8 \text { pin SSOP } \\ (175 \mathrm{mil}) \end{gathered}$ | PDC, IS-136, PHS |
| $\mu \mathrm{PG131G}$ | +30 | 0.6 @2G | 23 @2G | -4/0 |  | PHS, PCS, WLAN |
| $\mu \mathrm{PG132G}$ | +30 | 0.6 @1G | 22 @2G | +3/0 |  | PHS, PCS, WLAN |
| $\mu \mathrm{PG} 133 \mathrm{G}$ | +25 | 0.6 @2G | 20 @2G | $-3 / 0$ |  | DIVERSITY etc |

Remark: As for detail information of series products, please refer to each data sheet.

## APPLICATION EXAMPLE (PHS)



## RECOMMENDED OPERATING CONDITIONS

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Control Voltage (ON) | VCont $^{2}$ | +2.7 | +3.0 | +5.0 | V |
| Control Voltage (OFF) | Vcont | -0.2 | 0 | +0.2 | V |
| Input Power Level | Pin |  | 27 | 29 | dBm |

ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| CHARACTERISTICS | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Insertion Loss | Lins |  | 0.6 | 1.0 | dB |  |
|  |  |  | 0.8 ${ }^{\text {Note1 }}$ |  |  | $\mathrm{f}=2.5 \mathrm{GHz}$ |
| Isolation | ISL | 20 | 22 |  | dB |  |
|  |  | $20^{\text {Note1 }}$ |  |  |  | $\mathrm{f}=2.5 \mathrm{GHz}$ |
| Input Return Loss | RLin | 11 |  |  | dB | $\mathrm{f}=100 \mathrm{MHz}$ to 2 GHz |
| Output Return Loss | RLout | 11 |  |  | dB | $\mathrm{V}_{\text {cont1 }}=0 \mathrm{~V}$ |
| Input Power at 1dB Compression Point | Pin $(1 d B)^{\text {Note2 }}$ | 27 | 30 |  | dBm | $V_{\text {cont2 }}=+3 \mathrm{~V}$ <br> or |
| Switching Speed | tsw |  | 30 |  | ns | $\mathrm{V}_{\text {cont1 }}=+3 \mathrm{~V}$ |
| Control Current | Icont |  |  | 50 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {cont2 }}=0 \mathrm{~V}$ |

Notes 1: Characteristic for reference at 2.0 to 2.5 GHz .
2: Pin $(1 \mathrm{~dB})$ is measured the input power level when the insertion loss increase more 1 dB than that of linear range.
All other characteristics are measured in linear range.

## NOTE ON CORRECT USE

- When the $\mu$ PG132G is used it is necessary to use DC blocking capacitor for No. 2 pin (OUT2), No. 5 pin (IN) and No. 7 pin (OUT1). The value of DC blocking capacitors should be chosen to accommodate the frequency of operation.
- Insertion loss and isolation of the IN-OUT2 is better than that of IN-OUT1, because No. 7 pin (OUT1) is placed to same side of No. 5 pin (IN).
- The distance between IC's GND pins and ground pattern of substrate should be as shorter as possible to avoid parasitic parameters.

TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )
Note This data is including loss of the test fixture.

IN-OUT1 INSERTION LOSS vs. FREQUENCY

f - Frequency - Hz

| Lins |
| :---: |

IN-OUT1 INPUT RETURN LOSS vs. FREQUENCY

f-Frequency - Hz

IN-OUT1 ISOLATION vs. FREQUENCY


IN-OUT1 OUTPUT RETURN LOSS vs. FREQUENCY

f-Frequency - Hz



IN-OUT2 INPUT RETURN LOSS vs. FREQUENCY

f- Frequency - Hz


IN-OUT2 ISOLATION vs. FREQUENCY


IN-OUT2 OUTPUT RETURN LOSS vs. FREQUENCY

f - Frequency - Hz



## Internal Equivalent Circuit

Between the GND pins and FETs of this IC, a capacitor of 3.6 pF for floating is inserted to realize switching between positive voltages of +3 V and 0 V . However, the basic configuration of the $\mu \mathrm{PG} 132 \mathrm{G}$ is the same as that of the $\mu \mathrm{PG} 131 \mathrm{G}$. In addition, the $\mu \mathrm{PG} 132 \mathrm{G}$ has a monitor pin and a resistor to check the internal circuitry.


## TEST BOARD



TEST CIRCUIT


C1, C2, C3 = 51 pF

## APPLICATIONS

## Dependency on control voltage

The input/output characteristics, insertion loss, and isolation characteristics hardly fluctuate up to Pin ( 1 dB ) $=+27$ dBm , even if the control voltage is changed in a range of +3.0 V to +5.0 V . When the $I C$ is used at $\mathrm{P}_{\text {in }}=+22 \mathrm{dBm}$ in a PHS extension, therefore, the characteristics of the IC do not fluctuate even if a battery whose discharging characteristics fluctuate, such as a lithiumion battery, is used.

Relation between Control Voltage and Input/Output Characteristics


Relation between Small Signal Characteristics and Control Voltage


IN-OUT2 RETURN LOSS vs. FREQUENCY


IN-OUT2 ISOLATION vs. FREQUENCY


Frequency freq. (Hz)


IN-OUT2 OUTPUT RETURN LOSS vs. FREQUENCY


|  | $\mathrm{V}_{\text {cont1 }}=+3 \mathrm{~V}$ (isolation only, $\mathrm{V}_{\text {cont2 }}=+3 \mathrm{~V}$ ) |
| :---: | :---: |
| --..- | $\mathrm{V}_{\text {cont1 }}=+4 \mathrm{~V}$ (isolation only, $\mathrm{V}_{\text {cont2 }}=+4 \mathrm{~V}$ ) |
| --- | $\mathrm{V}_{\text {cont1 }}=+5 \mathrm{~V}$ (isolation only, $\mathrm{V}_{\text {cont2 }}=+5 \mathrm{~V}$ ) |

The measured values include all losses of the measuring jig.

Relation between Control Voltage and Second Harmonic


Relation between Control Voltage and Third Harmonic


## Temperature characteristics

Next, results from evaluating the temperature characteristics of the $\mu \mathrm{PG} 132 \mathrm{G}$ are shown. As shown, favorable characteristics are obtained in a range of $\mathrm{T}_{\mathrm{A}}=-55$ to $+90^{\circ} \mathrm{C}$. The temperature coefficient of the insertion loss is about $+0.0014 \mathrm{~dB} /{ }^{\circ} \mathrm{C}$, indicating that the higher the temperature, the more the insertion loss.

Temperature Characteristics of Input/Output


## Temperature Characteristics of Insertion Loss, and Double and Triple Harmonics


$\mu$ PG132G TRUTH TABLE OF SWITCHING BY CONDITION OF CONTROL VOLTAGE

|  |  | Vcont1 |  |
| :---: | :---: | :---: | :---: |
|  |  | +3 V | 0 V |
| Vcont2 | +3 V |  |  |
|  | 0 V |  | IN -O OUT 1 |

8-PIN PLASTIC SHRINK SOP (175 mil) (Unit mm)


Detail of lead end


$0.3-0.06 \bigoplus 0.10$ (M)
$\square 0.15$

## RECOMMENDED SOLDERING CONDITIONS

This product should be soldered in the following recommended conditions. Other soldering methods and conditions than the recommended conditions are to be consulted with our sales representatives.
[ $\mu$ PG132G]

| Soldering process | Soldering conditions | Recommended condition symbol |
| :---: | :---: | :---: |
| Infrared ray reflow | Package peak temperature: $230^{\circ} \mathrm{C}$ <br> Hour: within 30 s . (more than $210^{\circ} \mathrm{C}$ ) <br> Time: 2 time, Limited days: no. Note | IR30-00-2 |
| VPS | Package peak temperature: $215^{\circ} \mathrm{C}$ <br> Hour: within 40 s . (more than $200^{\circ} \mathrm{C}$ ), <br> Time: 2 time, Limited days: no. Note | VP15-00-2 |
| Wave Soldering | Soldering tub temperature: less than $260^{\circ} \mathrm{C}$, Hour: within 10 s . Time: 1 time, Limited days: no. Note | WS60-00-1 |
| Pin part heating | Pin area temperature: less than $300^{\circ} \mathrm{C}$, Hour: within 10 s . Limited days: no. Note |  |

Note It is the storage days after opening a dry pack, the storage conditions are $25^{\circ} \mathrm{C}$, less than $65 \%$, RH.

Caution The combined use of soldering method is to be avoided (However, except the pin area heating method).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535EJ7VOIF00).

The application circuits and their parameters are for references only and are not intended for use in actual designin's.

## Caution

> The Great Care must be taken in dealing with the devices in this guide. The reason is that the material of the devices is GaAs (Gallium Arsenide), which is designated as harmful substance according to the Japanese law concerned. Keep the law concerned and so on, especially in case of removal.

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